ON Semiconductor

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Onsemi

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MOSFET – Power, N-Channel, SO-8 30 V, 14.8 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- This is a Pb–Free Device

Applications

- Disk Drives
- DC-DC Converters
- Printers

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Param	neter		Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		$T_A = 25^{\circ}C$	I _D	12.2	А
Current $R_{\theta JA}$ (Note 1)		$T_A = 70^{\circ}C$	1	9.8	
Power Dissipation $R_{\theta JA}$ (Note 1)		T _A = 25°C	P _D	1.55	W
Continuous Drain		T _A = 25°C	I _D	9.1	А
Current R _{θJA} (Note 2)	Steady	T _A = 70°C		7.3	
Power Dissipation $R_{\theta JA}$ (Note 2)	State	$T_A = 25^{\circ}C$	P _D	0.86	W
Continuous Drain		T _A = 25°C	I _D	14.8	А
Current $R_{\theta JA}$, t \leq 10 s (Note 1)		$T_A = 70^{\circ}C$		11.8	
$\begin{array}{l} \mbox{Power Dissipation} \\ R_{\theta JA}, t \leq 10 \; s(\mbox{Note 1}) \end{array}$		T _A = 25°C	PD	2.3	W
Pulsed Drain Current	T _A = 25°	C, t _p = 10 μs	I _{DM}	50	А
Operating Junction and Storage Temperature			Т _Ј , T _{stg}	–55 to 150	°C
Source Current (Body Diode)			ا _S	2.9	А
Single Pulse Drain-to-Source Avalanche Energy $(T_J = 25^{\circ}C, V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_L = 14 \text{ A}_{pk}, L = 1.0 \text{ mH}, R_G = 25 \Omega)$			E _{AS}	98	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	80.5	°C/W
Junction-to-Ambient $-t \le 10 \text{ s}$ (Note 1)	$R_{\theta JA}$	54.9	
Junction-to-Foot (Drain)	$R_{\theta JF}$	19.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	145	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

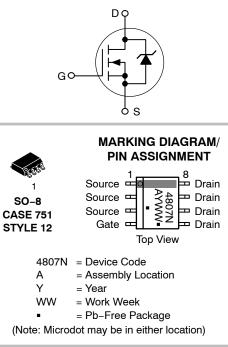


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V _{(BR)DSS}	R _{DS(ON)} MAX I _D MAX		
30 V	6.1 mΩ @ 10 V	14.8 A	
	7.5 mΩ @ 4.5 V	14.0 A	

N-Channel



ORDERING INFORMATION

Device	Package	Shipping [†]
NTMS4807NR2G	SO-8 (Pb-Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

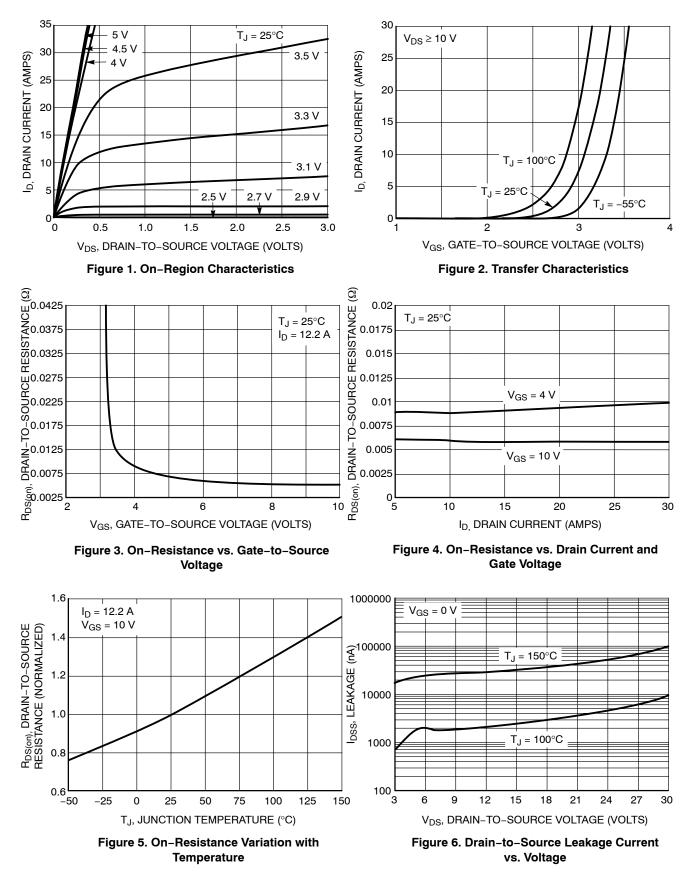
Surfacemounted on FR4 board using 1 in sq pad size.
Surfacemounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

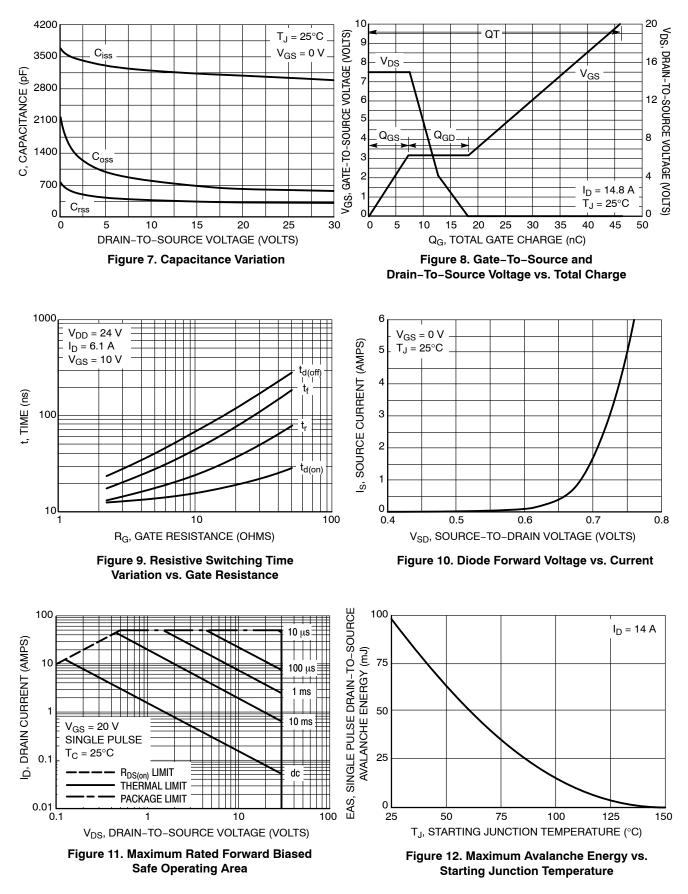
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 2$	50 μΑ	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				29		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 24 V	T _J = 25°C T _J = 100°C			1.0 10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =				±100	nA
ON CHARACTERISTICS (Note 3)	466						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 2	250 uA	1.5		3.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J		V		6.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D =	14.8 A		5.1	6.1	mΩ
		V _{GS} = 4.5 V, I _D =	12 A		6.5	7.5	1
Forward Transconductance	9 FS	V _{DS} = 1.5 V, I _D =	14.8 A		16		S
CHARGES, CAPACITANCES AND GA	ATE RESISTAN	NCE					
Input Capacitance	C _{iss}				2900		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz	V _{DS} = 24 V		562		
Reverse Transfer Capacitance	C _{rss}				307		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 14.8 A			24		nC
Threshold Gate Charge	Q _{G(TH)}				3.4		-
Gate-to-Source Charge	Q _{GS}				7.7		
Gate-to-Drain Charge	Q _{GD}				10.4		1
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V	′, I _D = 14.8 A		46		nC
SWITCHING CHARACTERISTICS (No	. · · ·						
Turn-On Delay Time	t _{d(on)}				14		ns
Rise Time	t _r	V _{GS} = 10 V, V _{DS} =	- 15 V		6.5		1
Turn-Off Delay Time	t _{d(off)}	$I_{\rm D} = 1.0 \text{ A}, \text{ R}_{\rm G} =$			47		1
Fall Time	t _f				17		1
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}		$T_J = 25^{\circ}C$		0.75	1.0	V
		V_{GS} = 0 V, I _S = 2.9 A	T _J = 125°C		0.58		
Reverse Recovery Time	t _{RR}				30		ns
Charge Time	ta	V_{GS} = 0 V, d_{IS}/d_{t} = 100 A/µs, I_{S} = 2.9 A			15		
Discharge Time	t _b				15		1
Reverse Recovery Charge	Q _{RR}				23		nC
PACKAGE PARASITIC VALUES		•			•	-	
Source Inductance	L _S	T _A = 25°C			0.66		nH
Drain Inductance	L _D	T _A = 25°C			0.20		nH
Gate Inductance	L _G	T _A = 25°C			1.5		nH
Gate Resistance	R _G	T _A = 25°C			0.9	1.4	Ω

4. Switching characteristics are independent of operating junction temperatures.

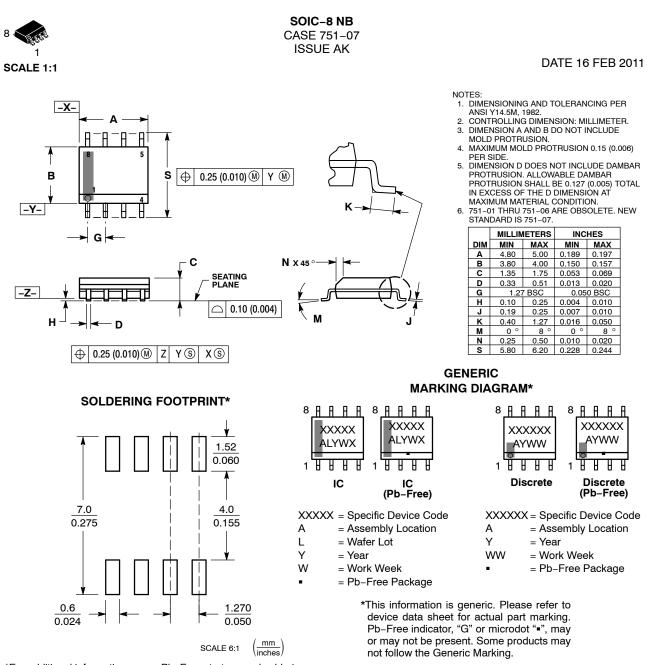
TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES







*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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SOIC-8 NB CASE 751-07 **ISSUE AK**

STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER EMITTER 5. BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6. BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 COMMON ANODE/GND 8. STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5.

6.

7.

8 GATE 1

SOURCE 1/DRAIN 2

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. 4. DRAIN, #2 GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. З. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. LINE 1 OUT 8. STYLE 27: PIN 1. ILIMIT OVI O 2 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

DATE 16 FEB 2011

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6 DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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COLLECTOR, #1

COLLECTOR, #1

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